Thermal Characteristics T <sub>A</sub> =25°C unless otherwise noted							
Symbol	Parameter	M	Max.				
		J108 - 110	*MMBFJ108	Units			
PD	Total Device Dissipation	625	350	mW			
	Derate above 25°C	5.0	2.8	mW/°C			
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125		°C/W			
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	556	°C/W			
* Device mounted on FR-4 PCB 1.6" × 1.6" × 0.06"							

J108/J109/J110/MMBFJ108

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## **PRODUCT STATUS DEFINITIONS**

### **Definition of Terms**

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